STATUS REPORT IR Detector Technology Development

Oct 9, 1997

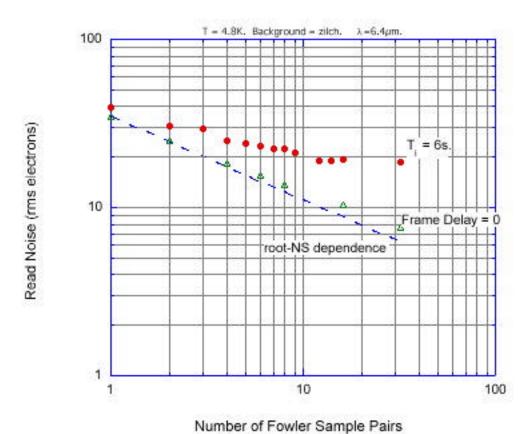
Craig McCreight
ARC

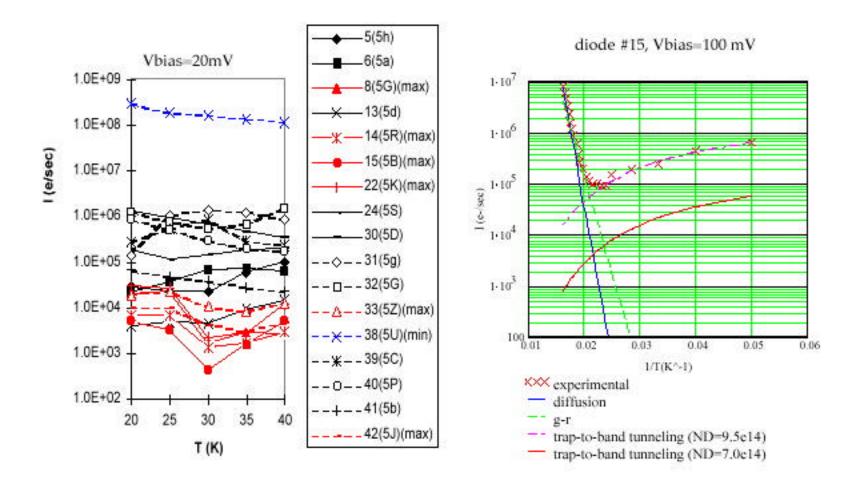
- Recent Accomplishments
 - InSb
 - Si:As IBC
 - HgCdTe
- Development Status
 - Ongoing Projects
 - New Activities
- **Goals for next 4 Months**

Recent Accomplishments

NGST

- All "primary" NGST development projects were presented at Tech Challenge Review.
- Large-format <u>InSb</u> arrays (W. Forrest, U Rochester, & SBRC)
 - Develop buttable 1k x 1k arrays, with <3 e- read noise and 0.01 e-/s dark current
 - 1st-year focus on reducing noise, with improved readouts. Identified 2 3 leading candidates for lot splits -- modifications of basic unit cell circuit.
- Large-format Si: As impurity band conduction (IBC) arrays (C. McCreight, ARC, & SBRC)
 - Develop 256 x 256 and 1k x 1k arrays, with <3 e- read noise and 0.05/10 e-/s dark current
 - Defined and laid out next generation readout for IBC array: 412 x 512 pixels
- Arrays of HgCdTe (10 µm) for NGST (J. Pipher, U Rochester, & Rockwell)
 - Develop HgCdTe detrs & arrays, T ~ 25-30 K, understand & reduce (~100 e-/s) dark current
 - Recent series of selected arrays, on NICMOS muxes, under test





Common Readout Developmen t

- Plan definitized at SBRC meeting 8/19. Will save approximately 20% of costs, by combining readout needs for InSb and Si:As IBC projects.
- Builds on CRC-744 readout design. Includes 256 x 256 and 412 x 512 structures.
- Costs shared with SIRTF/IRAC likely, too.
- Masks being fabricated; lot runs imminent.

"Primary" Technologies

All (InSb for near-IR, Si:As & 10-μm HgCdTe for thermal-IR) funded & rolling

"Backup" Technologies

- Plan to competitively select 1 backup activity for near-IR, and 1 for thermal-IR
- Funding via pooled NGST and Code SM technology resources
- Procurement approach: midrange R&D RFO
- Statements of Work completed in <u>draft</u> form

Goals for Next Four Months

Goddard Space Flight Center

- InSb: Complete analysis, design, & layout of advanced input test circuits. Initiate fabrication.
- Si:As: Complete design & layout of large readout. Start fabrication. Complete fabrication of new IBC material lot.
- HgCdTe: Complete dark current tests on present devices. Initiate fabrication of improved lot.

"Backups"

RFOs (2) released, under evaluation, anticipating awards ~Feb/Mar.